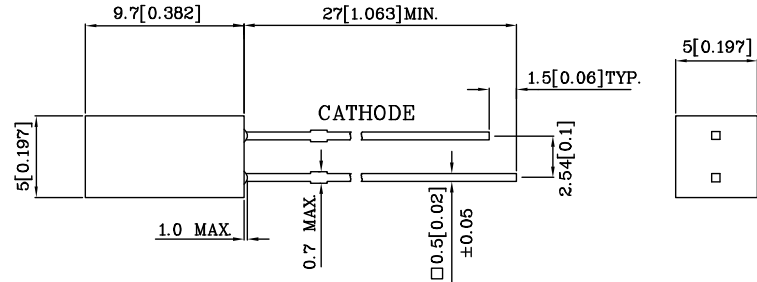


Features

- LOW POWER CONSUMPTION.
- WIDE VIEWING ANGLE.
- RRELIABLE AND RUGGED.
- EXCELLENT UNIFORMITY OF LIGHT OUTPUT.
- IDEAL AS FLUSH MOUNTED PANEL INDICATORS.
- LONG LIFE - SOLID STATE RELIABILITY.
- RoHS COMPLIANT.



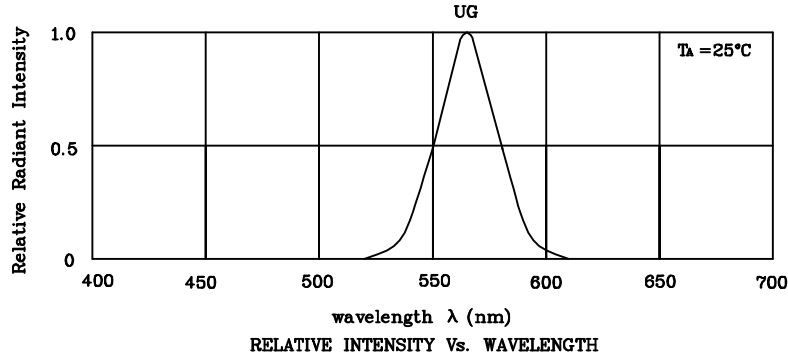
Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is $\pm 0.25(0.01)$ unless otherwise noted.

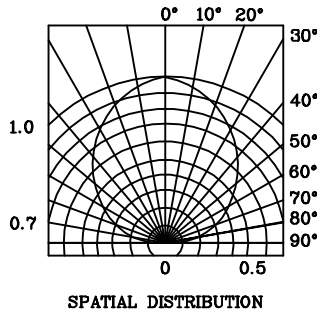
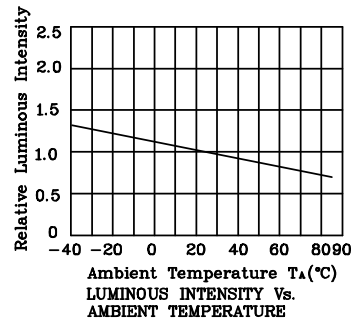
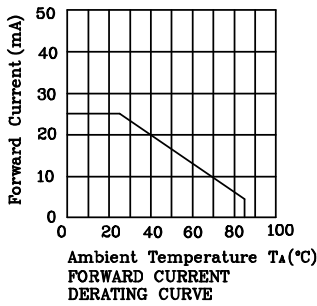
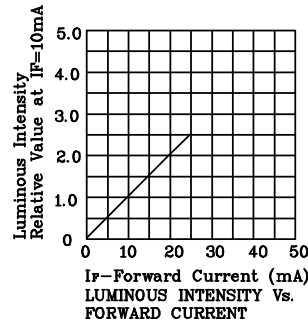
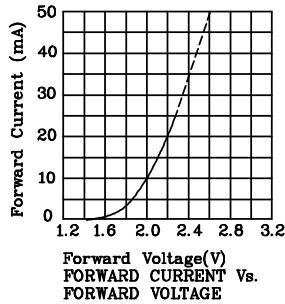
Absolute maximum ratings ($T_A=25^\circ\text{C}$)		UG (GaP)	Unit
Reverse Voltage	V_R	5	V
Forward Current	I_F	25	mA
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	i_{FS}	140	mA
Power Dissipation	P_T	105	mW
Operating Temperature	T_A	-40 ~ +85	°C
Storage Temperature	T_{stg}	-40 ~ +85	
Lead Solder Temperature [2mm Below Package Base]	260°C For 3 Seconds		
Lead Solder Temperature [5mm Below Package Base]	260°C For 5 Seconds		

Operating Characteristics ($T_A=25^\circ\text{C}$)		UG (GaP)	Unit
Forward Voltage (Typ.) ($I_F=10\text{mA}$)	V_F	2.0	V
Forward Voltage (Max.) ($I_F=10\text{mA}$)	V_F	2.5	V
Reverse Current ($V_R=5\text{V}$)	I_R	10	μA
Wavelength of Peak Emission ($I_F=10\text{mA}$)	λ_P	565	nm
Wavelength of Dominant Emission ($I_F=10\text{mA}$)	λ_D	568	nm
Spectral Line Full Width At Half-Maximum ($I_F=10\text{mA}$)	$\Delta\lambda$	30	nm
Capacitance ($V_F=0\text{V}$, $f=1\text{MHz}$)	C	15	pF

Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity ($I_F=10\text{mA}$) mcd		Wavelength nm λ_P	Viewing Angle 2θ 1/2
				min.	typ.		
XSUG10D	Green	GaP	Green Diffused	1	4.8	565	110°
Published Date : MAY 26,2005 Drawing No : XDSA2515 V3 Checked : B.L.LIU P.1/3							



❖ UG



Remarks:

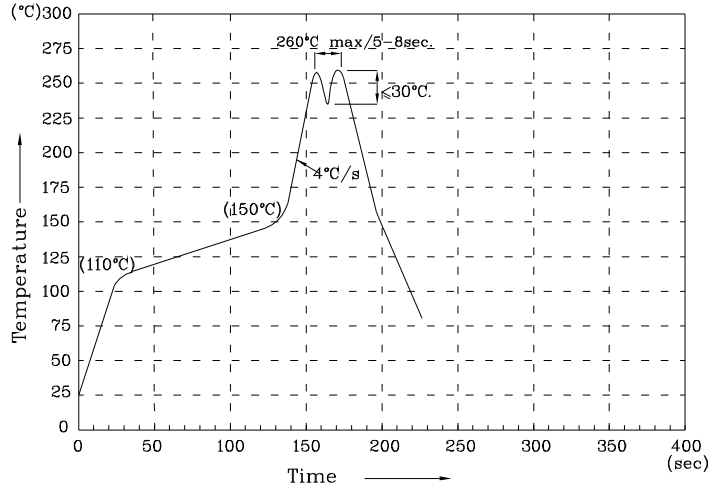
If special sorting is required (e.g. binning based on forward voltage, luminous intensity or wavelength), the typical accuracy of the sorting process is as follows:

1. Wavelength: +/-1nm
2. Luminous Intensity: +/-15%
3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.

XSUG10D

Wave Soldering Profile For Lead-free Through-hole LED.



NOTES:

- 1.Recommend the wave temperature 245°C~260°C.The maximum soldering temperature should be less than 260°C.
- 2.Do not apply stress on epoxy resins when temperature is over 85 degree°C.
- 3.The soldering profile apply to the lead free soldering (Sn/Cu/Ag alloy).
- 4.No more than once.